Rochester Electronics

Datasheet

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
    - Class Q Military
    - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)

- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

National Semiconductor

Not Intended For New Designs

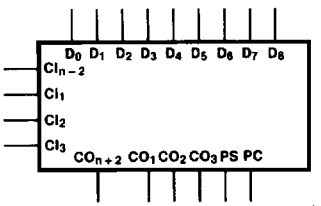
100182
9-Bit Wallace Tree Adder

General Description

The 100182 is a 9-bit Wallace tree adder. It is designed to assist in performing high-speed hardware multiplication. The device is designed to add 9 bits of data 1-bit-slice wide and handle the carry-ins from the previous slices. The 100182 is easily expanded and still maintains four levels of delay regardless of input string length. In conjunction with the 100183 Recode Multiplier, the 100179 Carry Lookahead, and the 100180 High-speed Adder, the 100182 assists in performing parallel multiplication of two signed numbers to produce a signed twos complement product. See 100183 data sheet for additional information. All inputs have 50 kΩ pull-down resistors.

Ordering Code: See Section 6

Logic Symbol



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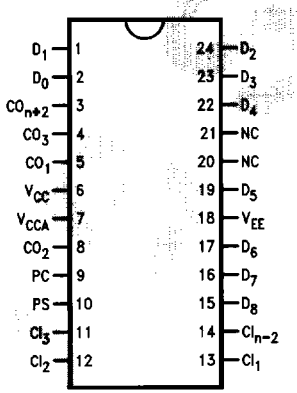
Pin Names	Description
D_0–D_8	Data Inputs
CI_1–CI_3, CI_{n-2}	Carry Inputs
CO_1–CO_3, CO_{n+2}	Carry Outputs
PS	Partial Sum Output
PC	Partial Carry Output

Connection Diagrams

24-Pin DIP



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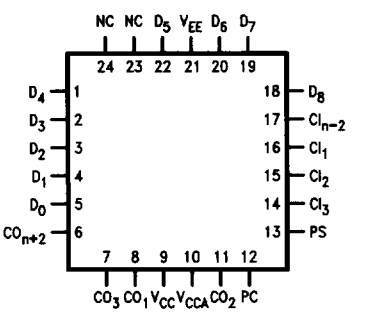
24-Pin Quad Cerpak



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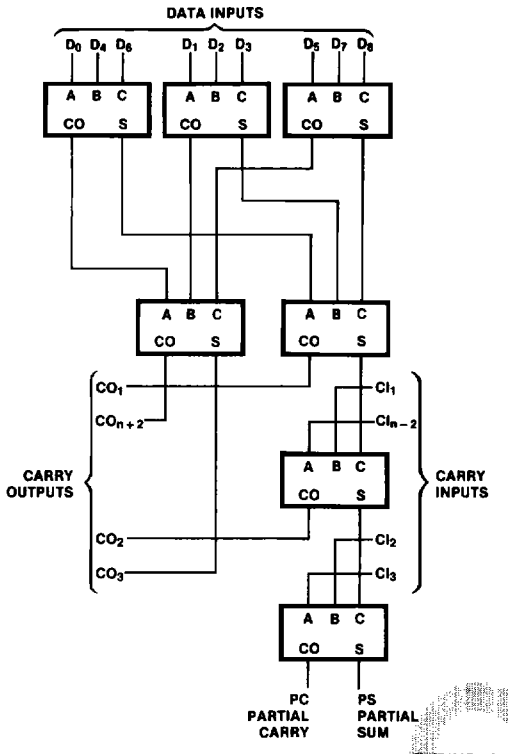
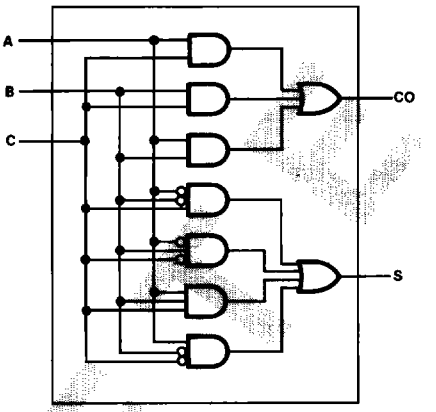
Logic Diagram



Adder Logic Diagram



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Adder Truth Table

Inputs			Outputs	
A	B	C	S	CO
L	L	L	L	L
L	L	H	H	L
L	H	L	H	L
L	H	H	L	H
H	L	L	H	L
H	L	H	L	H
H	H	L	L	H
H	H	H	H	H

Absolute Maximum Ratings

Above which the useful life may be impaired. (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	−65°C to +150°C
Maximum Junction Temperature (T_J)	+150°C
Case Temperature under Bias (T_C)	0°C to +85°C
V_{EE} Pin Potential to Ground Pin	−7.0V to +0.5V
Input Voltage (DC)	V_{EE} to +0.5V
Output Current (DC Output HIGH)	−50 mA
Operating Range (Note 2)	−5.7V to −4.2V

DC Electrical Characteristics

V_{EE} = −4.5V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions (Note 4)	
V_{OH}	Output HIGH Voltage	−1025	−955	−880	mV	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$	Loading with 50Ω to −2.0V
V_{OL}	Output LOW Voltage	−1810	−1705	−1620			
V_{OHC}	Output HIGH Voltage	−1035			mV	V_{IN} = $V_{IH(Min)}$ or $V_{IL\ (Max)}$	Loading with 50Ω to −2.0V
V_{OLC}	Output LOW Voltage			−1610			
V_{IH}	Input HIGH Voltage	−1165		−880	mV	Guaranteed HIGH Signal for All Inputs	
V_{IL}	Input LOW Voltage	−1810		−1475	mV	Guaranteed LOW Signal for All Inputs	
I_{IL}	Input LOW Current	0.50			μA	V_{IN} = $V_{IL\ (Min)}$	

DC Electrical Characteristics

V_{EE} = −4.2V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions (Note 4)	
V_{OH}	Output HIGH Voltage	−1020		−870	mV	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$	Loading with 50Ω to −2.0V
V_{OL}	Output LOW Voltage	−1810		−1605			
V_{OHC}	Output HIGH Voltage	−1030			mV	V_{IN} = $V_{IH\ (Min)}$ or $V_{IL\ (Max)}$	Loading with 50Ω to −2.0V
V_{OLC}	Output LOW Voltage			−1595			
V_{IH}	Input HIGH Voltage	−1150		−870	mV	Guaranteed HIGH Signal for All Inputs	
V_{IL}	Input LOW Voltage	−1810		−1475	mV	Guaranteed LOW Signal for All Inputs	
I_{IL}	Input LOW Current	0.50			μA	V_{IN} = $V_{IL\ (Min)}$	

DC Electrical Characteristics

V_{EE} = −4.8V, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions (Note 4)	
V_{OH}	Output HIGH Voltage	−1035		−880	mV	V_{IN} = $V_{IH\ (Max)}$ or $V_{IL\ (Min)}$	Loading with 50Ω to −2.0V
V_{OL}	Output LOW Voltage	−1830		−1620			
V_{OHC}	Output HIGH Voltage	−1045			mV	V_{IN} = $V_{IH\ (Min)}$ or $V_{IL\ (Max)}$	Loading with 50Ω to −2.0V
V_{OLC}	Output LOW Voltage			−1610			
V_{IH}	Input HIGH Voltage	−1165		−880	mV	Guaranteed HIGH Signal for All Inputs	
V_{IL}	Input LOW Voltage	−1830		−1490	mV	Guaranteed LOW Signal for All Inputs	
I_{IL}	Input LOW Current	0.50			μA	V_{IN} = $V_{IL\ (Min)}$	

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Parametric values specified at −4.2V to −4.8V.

Note 3: The specified limits represent the "worst case" value for the parameter. Since these "worst case" values normally occur at the temperature extremes, additional noise immunity and guard banding can be achieved by decreasing the allowable system operating ranges.

Note 4: Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

DC Electrical Characteristics

V_{EE} = −4.2V to −4.8V unless otherwise specified, V_{CC} = V_{CCA} = GND, T_C = 0°C to +85°C

Symbol	Parameter	Min	Typ	Max	Units	Conditions
I_{IH}	Input HIGH Current CI_1–CI_3, CI_{n-2} D_1, D_3, D_4, D_5, D_6, D_8			300	μA	V_{IN} = $V_{IH\ (Max)}$
	D_0, D_2, D_7			250		
I_{EE}	Power Supply Current	−260	−180	−125	mA	Inputs Open

Ceramic Dual-In-Line Package AC Electrical Characteristics

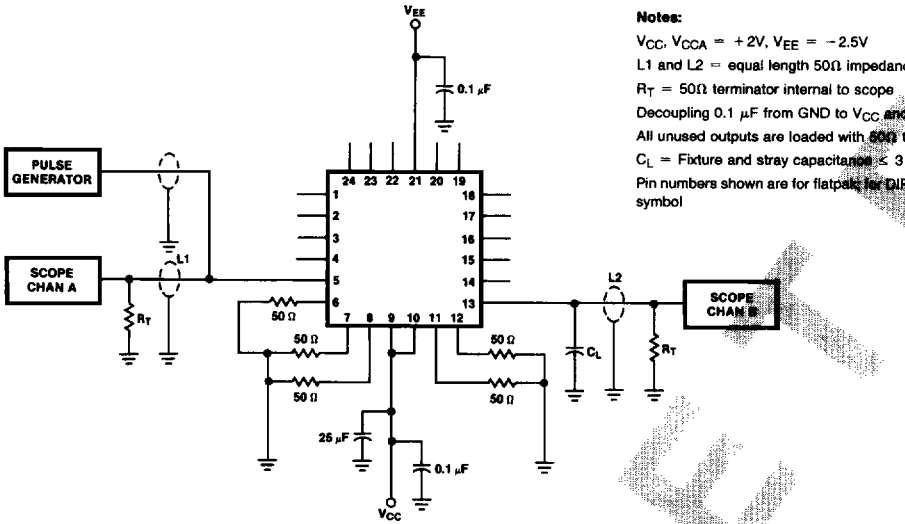
V_{EE} = −4.2V to −4.8V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_{n+2}	1.40	4.50	1.40	4.50	1.50	4.70	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_1	1.30	4.80	1.30	4.70	1.50	5.00	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_2	2.20	6.20	2.20	6.10	2.30	6.40	ns	*Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_3	1.30	4.70	1.40	4.70	1.50	5.00	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to PS, PC	2.50	7.20	2.50	7.20	2.70	7.40	ns	
t_{PLH} t_{PHL}	Propagation Delay CI_{n-2}, CI_1 to CO_2	1.00	3.50	1.00	3.40	1.10	3.70	ns	
t_{PLH} t_{PHL}	Propagation Delay CI_{n-2}, CI_1 to PS, PC	1.50	4.50	1.50	4.45	1.60	4.60	ns	*Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay CI_3, CI_2 to PS, PC	0.80	3.30	0.80	3.20	0.90	3.60	ns	
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.45	1.60	0.45	1.60	0.45	1.60	ns	*Figures 1* and *2*

Cerpak AC Electrical Characteristics

V_{EE} = −4.2V to −4.8V, V_{CC} = V_{CCA} = GND

Symbol	Parameter	T_C = 0°C		T_C = +25°C		T_C = +85°C		Units	Conditions
		Min	Max	Min	Max	Min	Max		
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_{n+2}	1.40	4.30	1.40	4.30	1.50	4.50	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_1	1.30	4.60	1.30	4.50	1.50	4.80	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_2	2.20	6.00	2.20	5.90	2.30	6.20	ns	*Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay D_n to CO_3	1.30	4.50	1.40	4.50	1.50	4.80	ns	
t_{PLH} t_{PHL}	Propagation Delay D_n to PS, PC	2.50	7.00	2.50	7.00	2.70	7.20	ns	
t_{PLH} t_{PHL}	Propagation Delay CI_{n-2}, CI_1 to CO_2	1.00	3.30	1.00	3.20	1.10	3.50	ns	
t_{PLH} t_{PHL}	Propagation Delay CI_{n-2}, CI_1 to PS, PC	1.50	4.30	1.50	4.25	1.60	4.40	ns	*Figures 1* and *2*
t_{PLH} t_{PHL}	Propagation Delay CI_3, CI_2 to PS, PC	0.80	3.10	0.80	3.00	0.90	3.40	ns	
t_{TLH} t_{THL}	Transition Time 20% to 80%, 80% to 20%	0.45	1.50	0.45	1.50	0.45	1.50	ns	*Figures 1* and *2*



Notes:

V_{CC}, V_{CCA} = +2V, V_{EE} = −2.5V

L1 and L2 = equal length 50Ω impedance lines

R_T = 50Ω terminator internal to scope

Decoupling 0.1 μF from GND to V_{CC} and V_{EE}

All unused outputs are loaded with 50Ω to GND

C_L = Fixture and stray capacitance ≤ 3 pF

Pin numbers shown are for flatpak for DIP see logic symbol

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FIGURE 1. AC Test Circuit

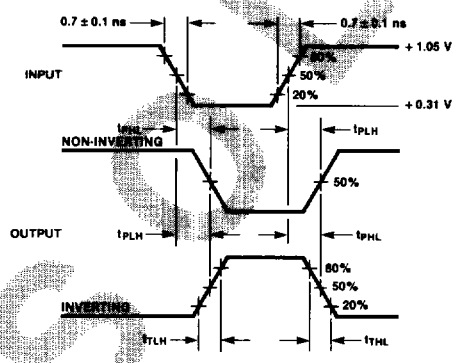

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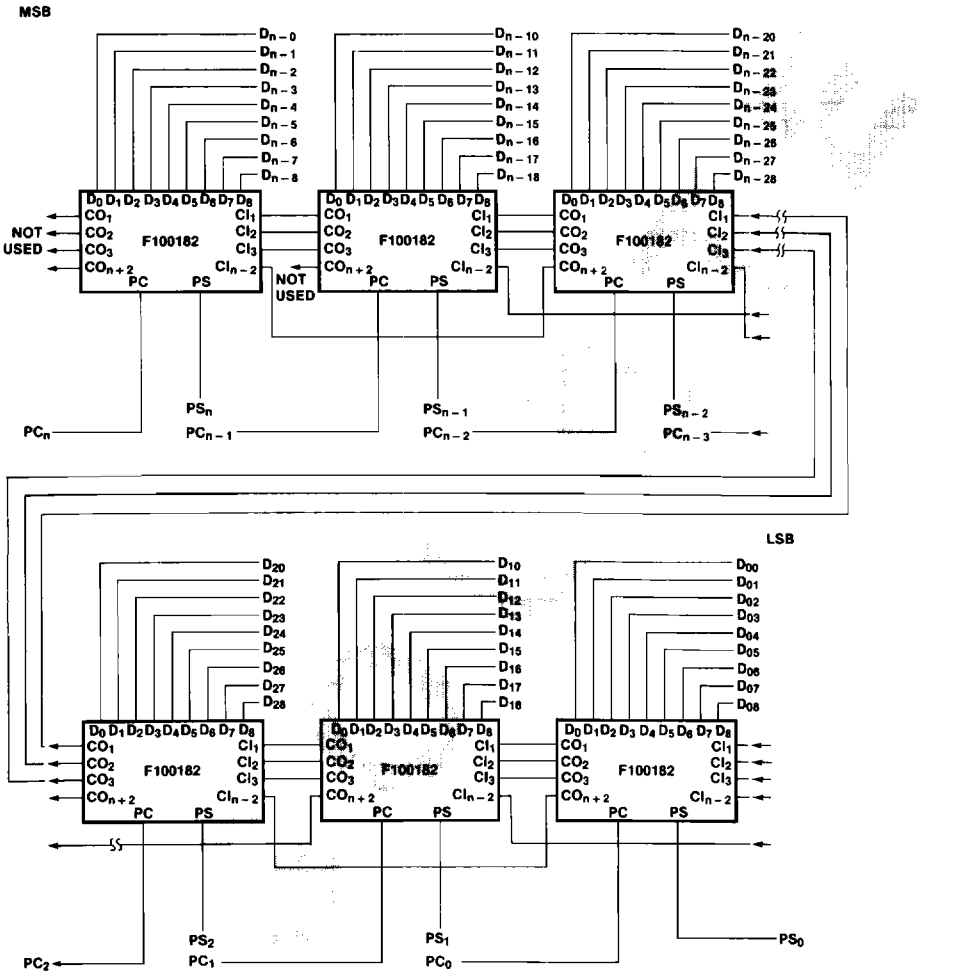
FIGURE 2. Propagation Delay and Transition Times

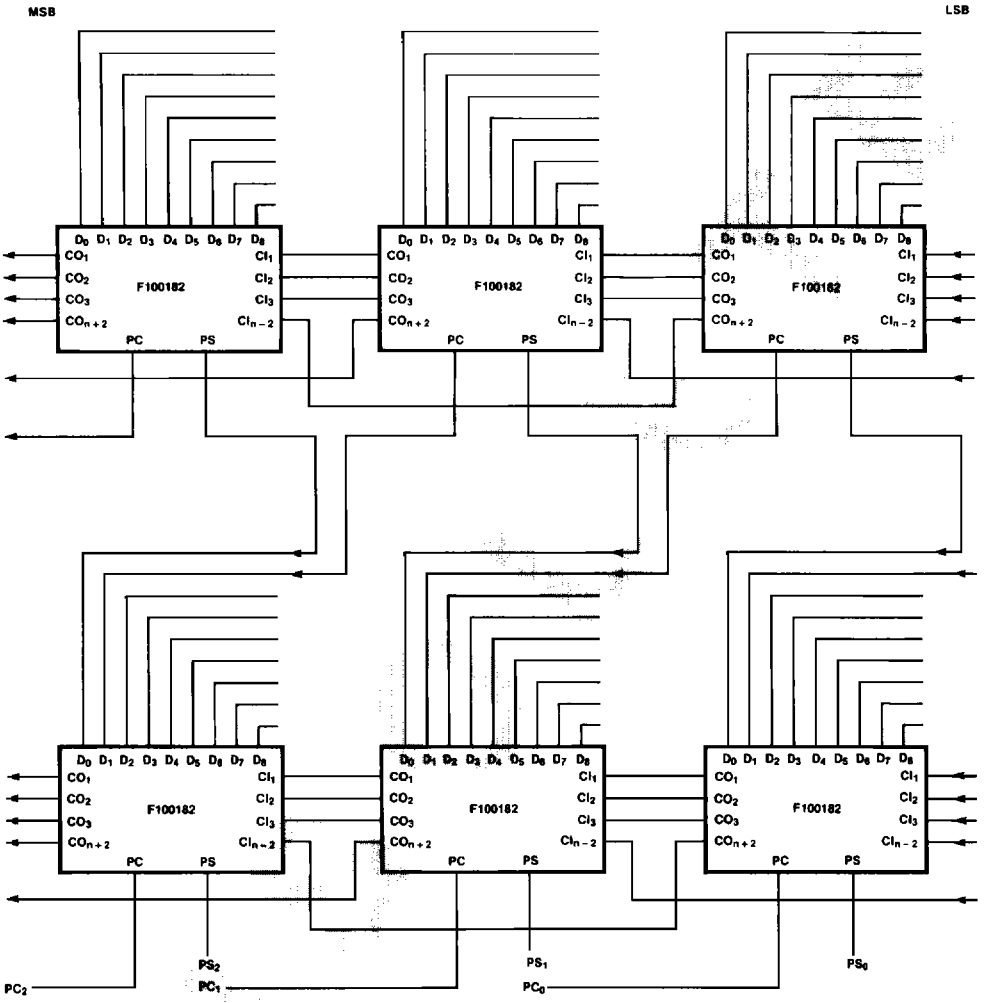
Application

Typical Horizontal Interconnection of 9-Bit Wallace Tree Adders F100182



Application (Continued)

16-Bit Vertical Expansion of Wallace Tree Adders



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